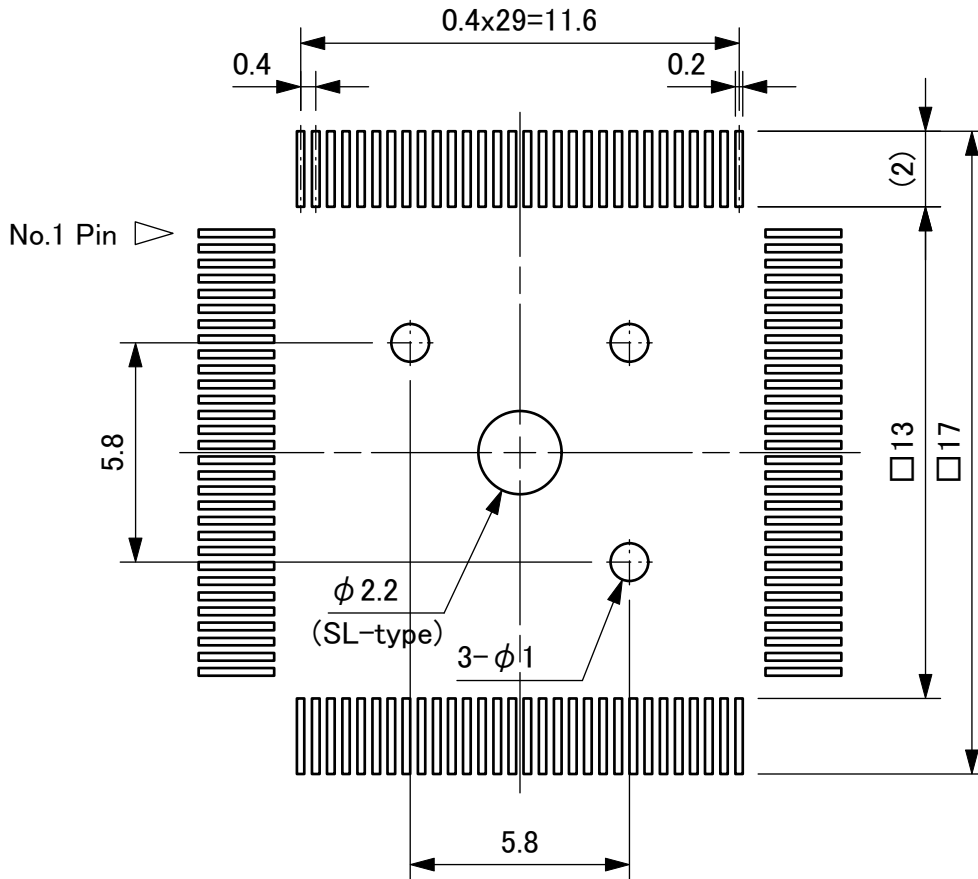


Recommended a Footprint pattern of  
NQPACK120SE-ND and NQPACK120SE



\* Recommended foot pattern shown on left is for NQPACK soldering.  
But please refer to IC package foot pattern recommended by IC manufacturer  
also, when the package is soldered on the same foot pattern.

Part No.	NQPACK120SE-ND
IC package	Square
Pin count	120Pin
Lead pitch	0.4
Unit	mm
Design / Date	M.Miura / Feb.24.'12
<i>TET</i> TOKYO ELETECH CORP.	